

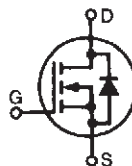
# PolarHV™ HiPerFET IXFR 80N50P

## Power MOSFET

### ISOPLUS247™

(Electrically Isolated Back Surface)

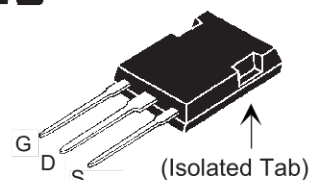
N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Diode



$$\begin{aligned} V_{DSS} &= 500 \text{ V} \\ I_{D25} &= 45 \text{ A} \\ R_{DS(on)} &\leq 72 \text{ m}\Omega \\ t_{rr} &\leq 200 \text{ ns} \end{aligned}$$

| Symbol     | Test Conditions                                                                                                                         | Maximum Ratings |                  |
|------------|-----------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------|
| $V_{DSS}$  | $T_J = 25^\circ\text{C to } 150^\circ\text{C}$                                                                                          | 500             | V                |
| $V_{DGR}$  | $T_J = 25^\circ\text{C to } 150^\circ\text{C}; R_{GS} = 1 \text{ M}\Omega$                                                              | 500             | V                |
| $V_{GSM}$  | Transient                                                                                                                               | $\pm 40$        | V                |
| $V_{GSM}$  | Continuous                                                                                                                              | $\pm 30$        | V                |
| $I_{D25}$  | $T_C = 25^\circ\text{C}$                                                                                                                | 45              | A                |
| $I_{DM}$   | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$                                                                              | 200             | A                |
| $I_{AR}$   | $T_C = 25^\circ\text{C}$                                                                                                                | 80              | A                |
| $E_{AR}$   | $T_C = 25^\circ\text{C}$                                                                                                                | 80              | mJ               |
| $E_{AS}$   | $T_C = 25^\circ\text{C}$                                                                                                                | 3.5             | J                |
| $dv/dt$    | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ ,<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 2 \Omega$ | 20              | V/ns             |
| $P_D$      | $T_C = 25^\circ\text{C}$                                                                                                                | 360             | W                |
| $T_J$      |                                                                                                                                         | -55 ... +150    | $^\circ\text{C}$ |
| $T_{JM}$   |                                                                                                                                         | 150             | $^\circ\text{C}$ |
| $T_{stg}$  |                                                                                                                                         | -55 ... +150    | $^\circ\text{C}$ |
| $T_L$      | Maximum lead temperature for soldering                                                                                                  | 300             | $^\circ\text{C}$ |
| $F_C$      | Mounting force                                                                                                                          | 20..120/4.5..25 | N/lb             |
| $V_{ISOL}$ | 50/60 Hz, RMS, 1 minute                                                                                                                 | 2500            | V~               |
| Weight     |                                                                                                                                         | 5               | g                |

ISOPLUS247 (IXFR)  
E153432



G = Gate  
S = Source  
D = Drain

#### Features

- Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Low drain to tab capacitance(<30pF)
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Rated for Unclamped Inductive Load Switching (UIS)
- Fast intrinsic Rectifier

#### Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control

#### Advantages

- Easy assembly
- Space savings
- High power density

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ unless otherwise specified)   | Characteristic Values |      |                          |
|--------------|-----------------------------------------------------------------------------|-----------------------|------|--------------------------|
|              |                                                                             | Min.                  | Typ. | Max.                     |
| $BV_{DSS}$   | $V_{GS} = 0 \text{ V}$ , $I_D = 500 \mu\text{A}$                            | 500                   |      | V                        |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 8 \text{ mA}$                                    | 3.0                   |      | 5.0 V                    |
| $I_{GSS}$    | $V_{GS} = \pm 30 \text{ V}_{DC}$ , $V_{DS} = 0$                             |                       |      | $\pm 200 \text{ nA}$     |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$ ,<br>$V_{GS} = 0 \text{ V}$<br>$T_J = 125^\circ\text{C}$ |                       |      | 25 $\mu\text{A}$<br>2 mA |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$ , $I_D = 40 \text{ A}$                              |                       |      | 72 m $\Omega$            |

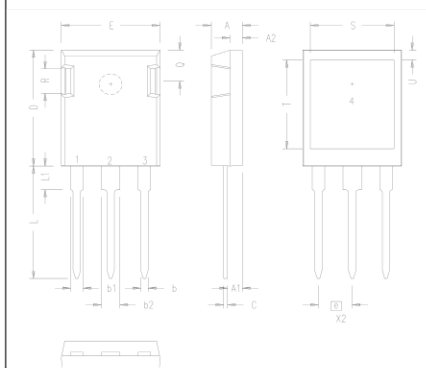
| Symbol                    | Test Conditions                                                                                                           | Characteristic Values<br>(T <sub>j</sub> = 25° C unless otherwise specified) |      |           |
|---------------------------|---------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------|------|-----------|
|                           |                                                                                                                           | Min.                                                                         | Typ. | Max.      |
| <b>g<sub>fs</sub></b>     | V <sub>DS</sub> = 20 V; I <sub>D</sub> = 40 A, I <sub>D25</sub> , Note 1                                                  | 45                                                                           | 70   | S         |
| <b>C<sub>iss</sub></b>    | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz                                                                  |                                                                              | 12.7 | nF        |
| <b>C<sub>oss</sub></b>    |                                                                                                                           |                                                                              | 1280 | pF        |
| <b>C<sub>rss</sub></b>    |                                                                                                                           |                                                                              | 120  | pF        |
| <b>t<sub>d(on)</sub></b>  | V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 0.5 V <sub>DSS</sub> , I <sub>D</sub> = 40 A<br>R <sub>G</sub> = 1 Ω (External) |                                                                              | 25   | ns        |
| <b>t<sub>r</sub></b>      |                                                                                                                           |                                                                              | 27   | ns        |
| <b>t<sub>d(off)</sub></b> |                                                                                                                           |                                                                              | 70   | ns        |
| <b>t<sub>f</sub></b>      |                                                                                                                           |                                                                              | 16   | ns        |
| <b>Q<sub>g(on)</sub></b>  | V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 0.5 V <sub>DSS</sub> , I <sub>D</sub> = 40 A                                    |                                                                              | 197  | nC        |
| <b>Q<sub>gs</sub></b>     |                                                                                                                           |                                                                              | 70   | nC        |
| <b>Q<sub>gd</sub></b>     |                                                                                                                           |                                                                              | 64   | nC        |
| <b>R<sub>thJC</sub></b>   |                                                                                                                           |                                                                              |      | 0.35° C/W |
| <b>R<sub>thCS</sub></b>   |                                                                                                                           |                                                                              | 0.15 | ° C/W     |

| Source-Drain Diode |                                                          | Characteristic Values                               |      |        |
|--------------------|----------------------------------------------------------|-----------------------------------------------------|------|--------|
|                    |                                                          | (T <sub>J</sub> = 25° C unless otherwise specified) |      |        |
| Symbol             | Test Conditions                                          | Min.                                                | Typ. | Max.   |
| I <sub>S</sub>     | V <sub>GS</sub> = 0 V                                    |                                                     |      | 80 A   |
| I <sub>SM</sub>    | Repetitive                                               |                                                     |      | 200 A  |
| V <sub>SD</sub>    | I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0 V, |                                                     |      | 1.5 V  |
| t <sub>rr</sub>    | I <sub>F</sub> = 25 A, -di/dt = 100 A/μs                 |                                                     |      | 200 ns |
| Q <sub>RM</sub>    | V <sub>R</sub> = 100 V, V <sub>GS</sub> = 0 V            |                                                     | 0.6  | μC     |
| I <sub>RM</sub>    |                                                          |                                                     | 6    | A      |

Notes:

1. Pulse test,  $t \leq 300 \mu s$ , duty cycle  $d \leq 2 \%$

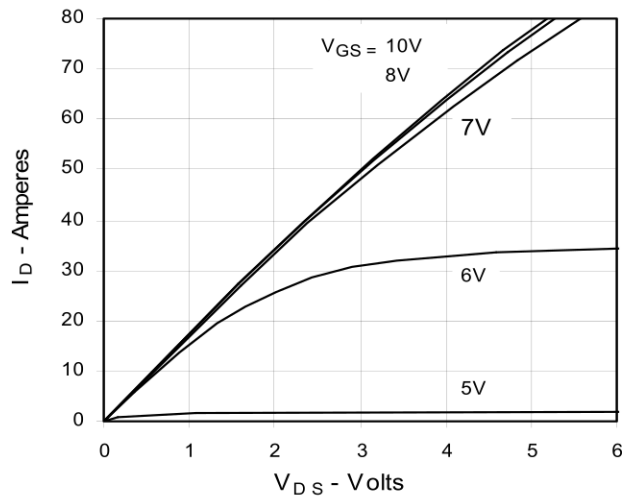
## ISOPLUS247™ Outline



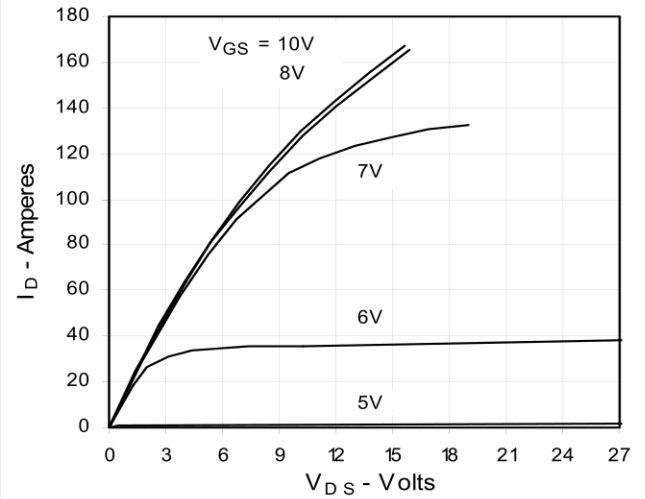
IXYS reserves the right to change limits, test conditions, and dimensions.

|                                                                                  |           |           |           |           |              |              |             |              |
|----------------------------------------------------------------------------------|-----------|-----------|-----------|-----------|--------------|--------------|-------------|--------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344   | 6,727,585    |
|                                                                                  | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405B2 | 6,759,692    |
|                                                                                  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463   | 6,771,478 B2 |

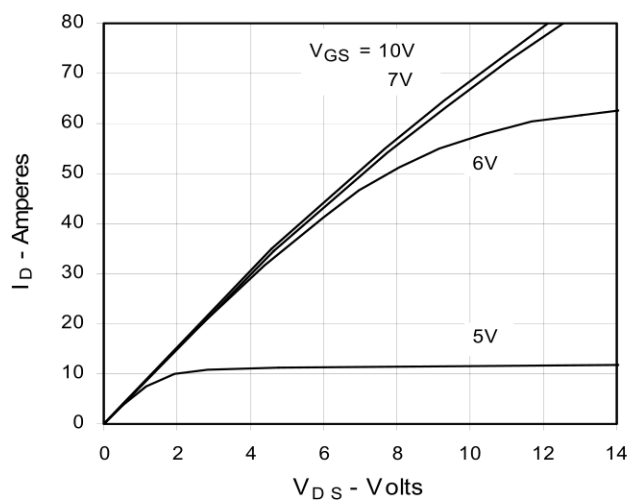
**Fig. 1. Output Characteristics  
@ 25°C**



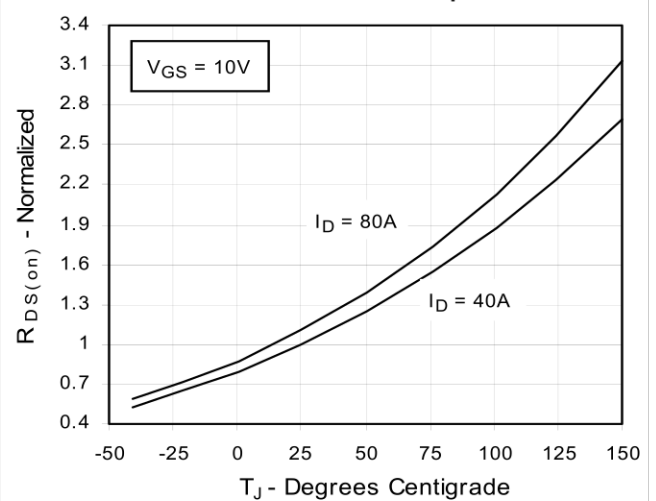
**Fig. 2. Extended Output Characteristics  
@ 25°C**



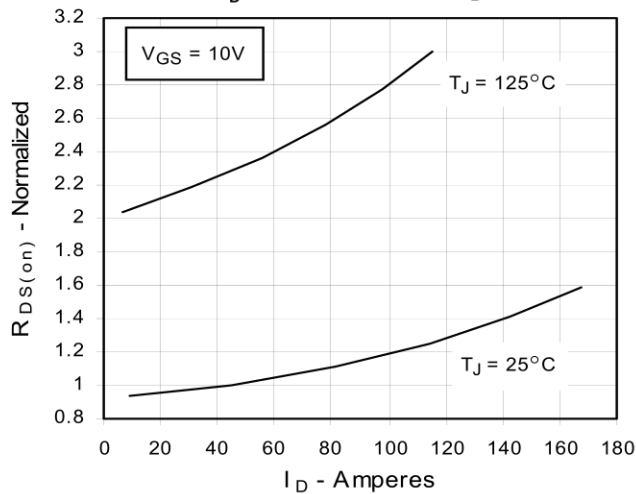
**Fig. 3. Output Characteristics  
@ 125°C**



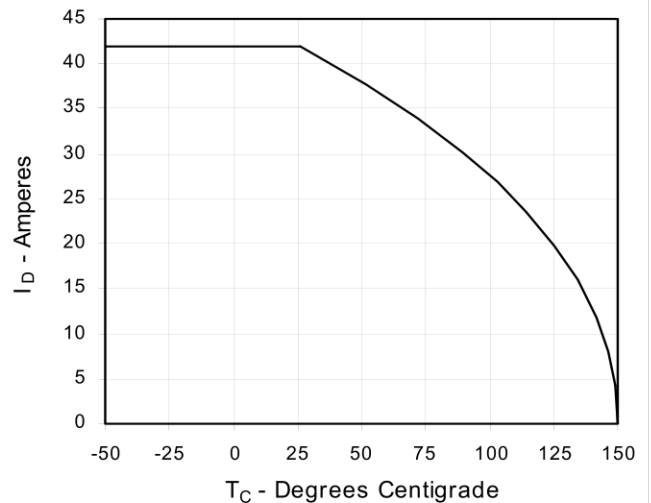
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 40 A$   
Value vs. Junction Temperature**



**Fig. 5.  $R_{DS(on)}$  Normalized to  
 $I_D = 40 A$  Value vs.  $I_D$**



**Fig. 6. Drain Current vs. Case  
Temperature**



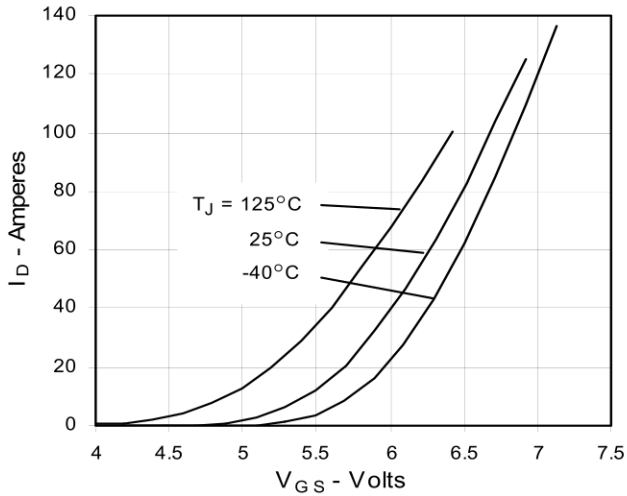
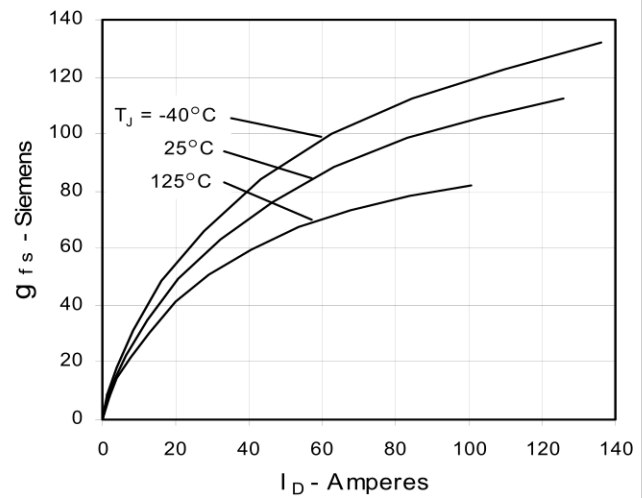
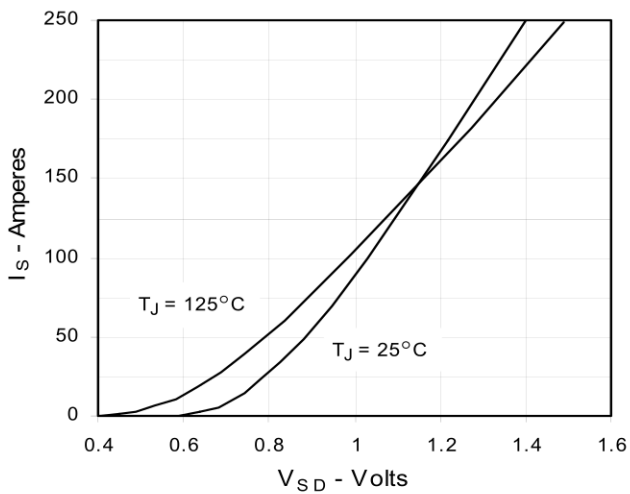
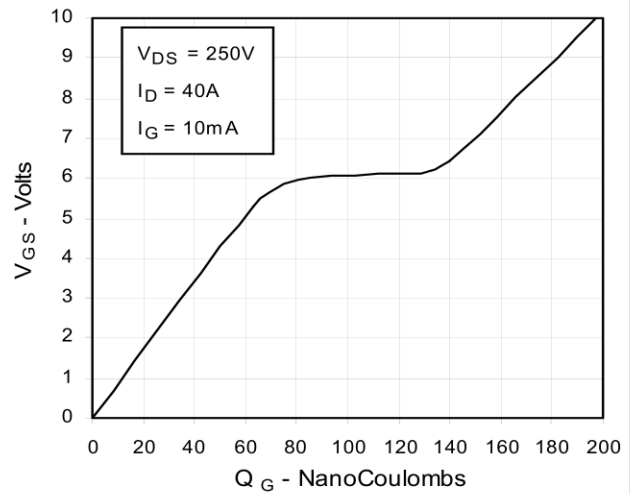
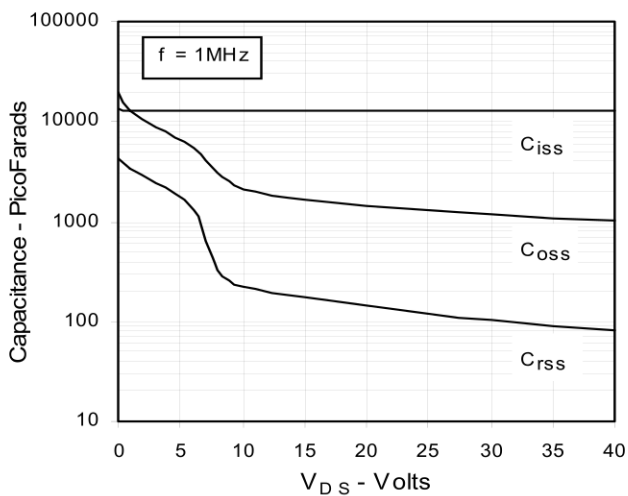
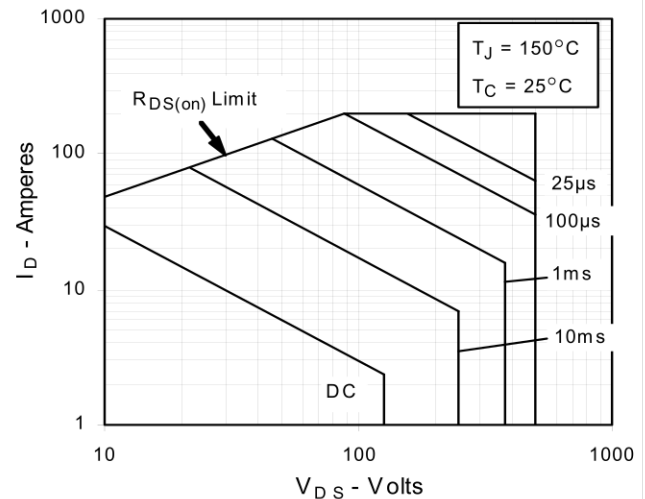
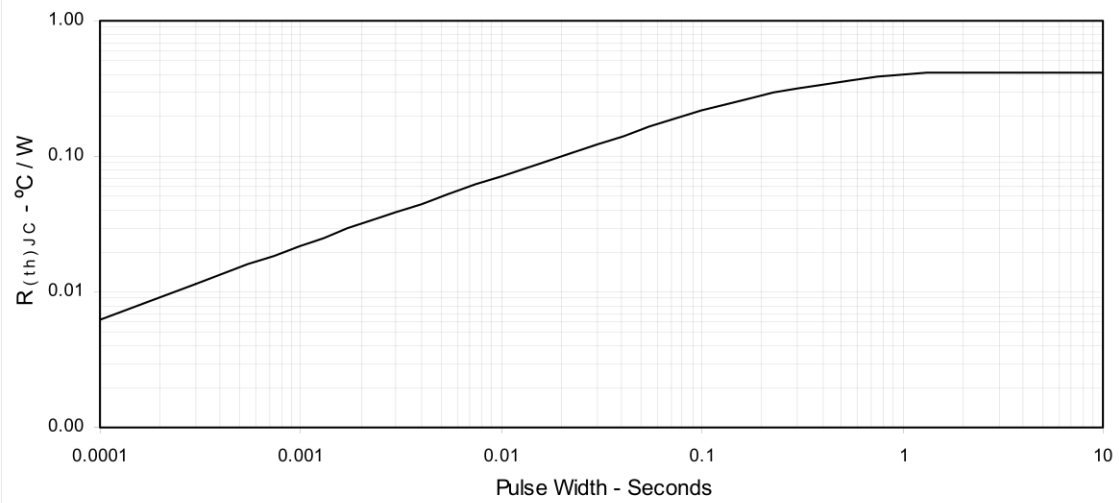
**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Source Current vs. Source-To-Drain Voltage**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Forward-Bias Safe Operating Area**


Fig. 13. Maximum Transient Thermal Resistance





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